Surface Mount Ultrafast Power Rectifiers

This series employs the state-of-the-art epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes, in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 3.0 A, T_J = 150°C)
- SURS8 Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

Mechanical Characteristics

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Device Meets MSL1 Requirements
- ESD Ratings:
 - Machine Model, C (> 400 V)
 - ♦ Human Body Model, 3B (> 8 kV)



ON Semiconductor®

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ULTRAFAST RECTIFIERS 3.0 AMPERES 200-600 VOLTS



SMC CASE 403 PLASTIC

MARKING DIAGRAM



U3 = Specific Device Code

c = D (320T3)

= G (340T3)

= J (360T3)

A = Assembly Location

= Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]		
MURS320T3G	SMC (Pb-Free)	2,500 / Tape & Reel		
SURS8320T3G	SMC (Pb-Free)	2,500 / Tape & Reel		
MURS340T3G	SMC (Pb-Free)	2,500 / Tape & Reel		
SURS8340T3G	SMC (Pb-Free)	2,500 / Tape & Reel		
MURS360T3G	SMC (Pb-Free)	2,500 / Tape & Reel		
SURS8360T3G	SMC (Pb-Free)	2,500 / Tape & Reel		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	MURS320T3G/ SURS8320T3G	MURS340T3G/ SURS8340T3G	MURS360T3G/ SURS8360T3G	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	400	600	V
Average Rectified Forward Current	I _{F(AV)}	3.0 @ T _L = 140°C 4.0 @ T _L = 130°C	3.0 @ T _L = 130°C 4.0 @ T _L = 115°C	3.0 @ T _L = 130°C 4.0 @ T _L = 115°C	Α
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100			A
Operating Junction Temperature	TJ	– 65 to +175			°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Lead	$R_{ hetaJL}$	11	°C/W	1
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1) $ \begin{aligned} &(i_F=3.0\text{ A},\text{ T}_J=25^{\circ}\text{C})\\ &(i_F=4.0\text{ A},\text{ T}_J=25^{\circ}\text{C})\\ &(i_F=3.0\text{ A},\text{ T}_J=150^{\circ}\text{C}) \end{aligned} $	VF	0.875 0.89 0.71	1.25 1.28 1.05	1.25 1.28 1.05	V
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 25^{\circ}\text{C}$) (Rated dc Voltage, $T_J = 150^{\circ}\text{C}$)	i _R	5.0 150	10 250	10 250	μΑ
Maximum Reverse Recovery Time $ \begin{aligned} &(i_F=1.0 \text{ A, di/dt}=50 \text{ A/}\mu\text{s}) \\ &(i_F=0.5 \text{ A, }i_R=1.0 \text{ A, }I_{REC} \text{ to }0.25 \text{ A}) \end{aligned} $	t _{rr}	35 25	75 50	75 50	ns
Maximum Forward Recovery Time (i _F = 1.0 A, di/dt = 100 A/μs, Recovery to 1.0 V)	t _{fr}	25	50	50	ns

^{1.} Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

MURS320T3G/SURS8320T3G

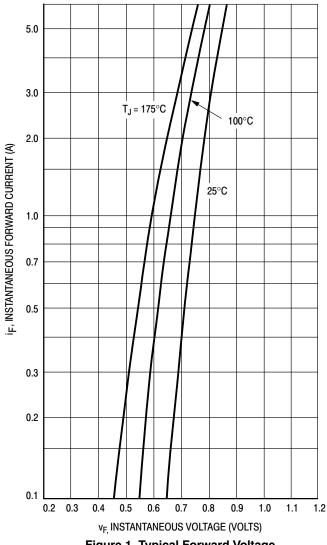


Figure 1. Typical Forward Voltage

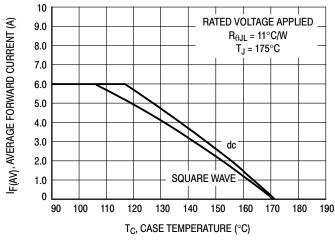


Figure 4. Current Derating, Case

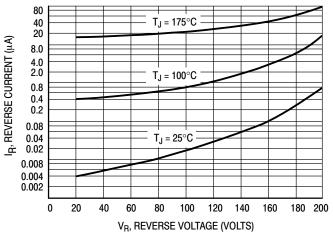


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

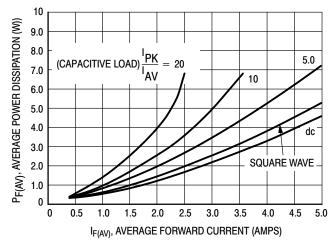


Figure 3. Power Dissipation

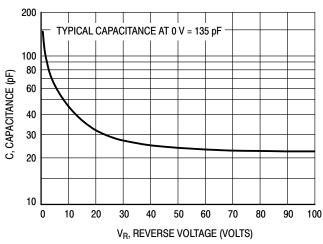


Figure 5. Typical Capacitance

MURS340T3G, SURS8340T3G, MURS360T3G, SURS8360T3G

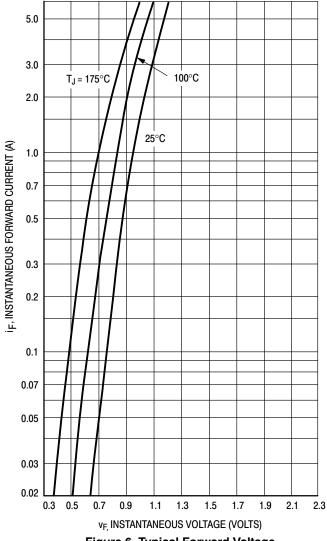


Figure 6. Typical Forward Voltage

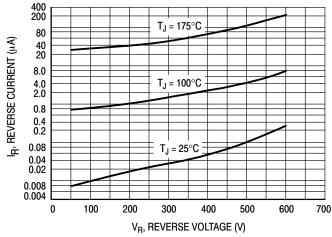


Figure 7. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

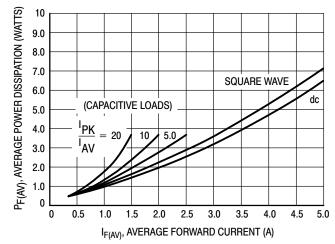


Figure 8. Power Dissipation

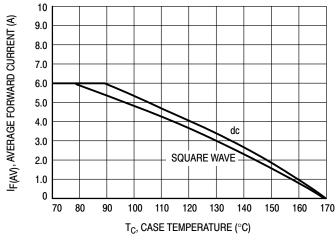


Figure 9. Current Derating, Case

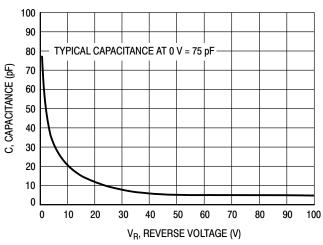


Figure 10. Typical Capacitance

MURS340T3G, SURS8340T3G, MURS360T3G, SURS8360T3G

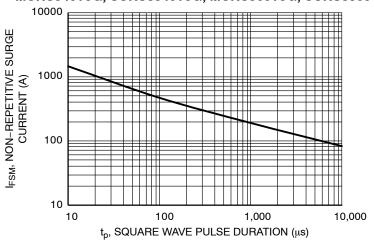
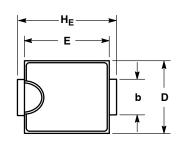


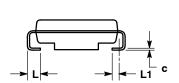
Figure 11. Typical Non-Repetitive Surge Current

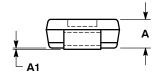
^{*}Typical performance based on a limited sample size. ON Semiconductor does not guarantee ratings not listed in the Maximum Ratings table.

PACKAGE DIMENSIONS

SMC PLASTIC PACKAGE CASE 403-03 **ISSUE E**



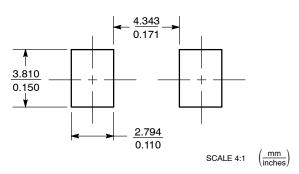




- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.
- 403-01 THRU -02 OBSOLETE, NEW STANDARD 403-03.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.90	2.13	2.41	0.075	0.084	0.095	
A1	0.05	0.10	0.15	0.002	0.004	0.006	
р	2.92	3.00	3.07	0.115	0.118	0.121	
С	0.15	0.23	0.30	0.006	0.009	0.012	
D	5.59	5.84	6.10	0.220	0.230	0.240	
Е	6.60	6.86	7.11	0.260	0.270	0.280	
HE	7.75	7.94	8.13	0.305	0.313	0.320	
L	0.76	1.02	1.27	0.030	0.040	0.050	
11	0.51 BEE				0.020 BEE		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Офис по работе с юридическими лицами:

105318, г. Москва, ул. Щербаковская д. 3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru moschip.ru_6 moschip.ru 4 moschip.ru 9